### **MK1160VP LDMOS TRANSISTOR**

Document Number: MK1160VP Preliminary Datasheet V1.0

### 1000-1100MHz, 50V, 600W, RF Power LDMOS Transistor

### Description

The MK1160VP is a 600-watt, internally matched LDMOS FETs, designed for civilian pulsed avionics amplifier applications with frequencies from 1000 MHz to 1100 MHz.

There is no guarantee of performance when this part is used in applications designed outside of these frequencies.

•Typical Performance(On Innogration fixture with device soldered):

 $V_{\text{DD}}$  = 50 Volts,  $I_{\text{DQ}}$  = 100 mA, Pulse CW, Pulse Width=10 us, Duty cycle=10% .

Frequency	Gain(dB)	P <sub>3dB</sub> (W)	η <sub>D</sub> @P <sub>3dB</sub> (%)
1030 MHz	13.9	700	46.5
1060 MHz	14.3	680	48.6
1090 MHz	14.5	664	50.7

Note: This device is only used as single-ended device.

### **Applications and Features**

- Avionics: Mode-S, TCAS, JTIDS, DME and TACAN
- Thermally Enhanced Industry Standard Package
- High Reliability Metallization Process
- Excellent thermal Stability and Excellent Ruggedness
- Compliant to Restriction of Hazardous Substances (RoHS) Directive 2002/95/EC

### Table 1. Maximum Ratings

Rating	Symbol	Value	Unit
DrainSource Voltage	V <sub>DSS</sub>	+110	Vdc
GateSource Voltage	V <sub>GS</sub>	-10 to +10	Vdc
Operating Voltage	V <sub>dd</sub>	+54	Vdc
Storage Temperature Range	Tstg	-65 to +150	°C
Case Operating Temperature	T <sub>c</sub>	+150	°C
Operating Junction Temperature	T	+225	°C

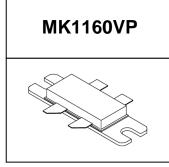
# Characteristic Symbol Value Unit Thermal Resistance, Junction to Case RθJC 0.07 °C/W

#### Table 3. ESD Protection Characteristics

Test Methodology	Class						
Human Body Model (per JESD22A114)	Class 2						
Table 4. Electrical Characteristics (TA = 25 °C unless otherwise noted)							

Characteristic	Symbol	Min	Тур	Max	Unit

**DC Characteristics** 



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Zero Gate Voltage Drain Leakage Current $(V_{DS} = 115V, V_{GS} = 0 V)$	I <sub>DSS</sub>		100	μΑ
Zero Gate Voltage Drain Leakage Current $(V_{DS} = 50 \text{ V}, V_{GS} = 0 \text{ V})$	I <sub>DSS</sub>		10	μΑ
GateSource Leakage Current ( $V_{GS} = 6 V, V_{DS} = 0 V$ )	I <sub>GSS</sub>		10	μΑ
Gate Threshold Voltage $(V_{DS} = 50V, I_D = 600 \ \mu A)$	V <sub>GS</sub> (th)	2.25		V
Gate Quiescent Voltage ( $V_{DD}$ = 50 V, $I_D$ = 100 mA, Measured in Functional Test)	V <sub>GS(Q)</sub>	2.8		V

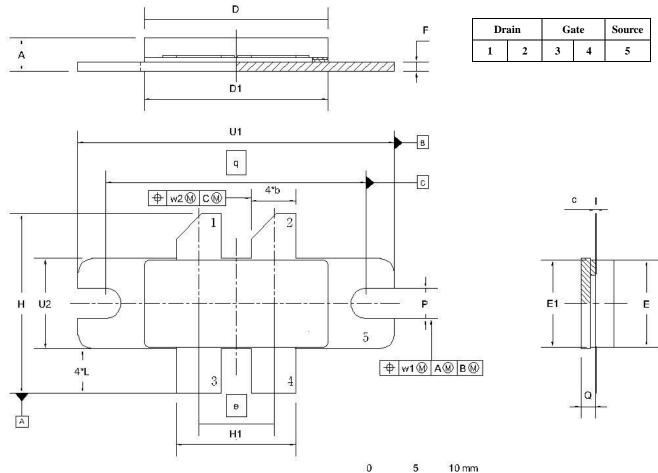
Functional Tests (On Innogration Test Fixture, 50 ohm system) :V<sub>DD</sub> = 50 Vdc, I<sub>DQ</sub> = 100 mA, f = 1090 MHz, Pulsed CW, Pulse

Width=10us, Duty cycle=10% .

Characteristic	Symbol	Min	Тур	Max	Unit		
Max Gain	Gp		14.5		dB		
3dB Compression Point	P <sub>3dB</sub>		664		W		
Drain Efficiency	η <sub>D</sub>		50.7		%		
Input Return Loss	IRL		-7		dB		
Load Mismatch (In Innogration Test Fixture, 50 ohm system): V <sub>DD</sub> = 50 Vdc, I <sub>DQ</sub> = 100 mA, f = 1090MHz							
VSWR 10:1 at 600W Pulsed CW Output Power	No Device Degradation						

### **Package Outline**

### Eared Flanged Ceramic Package; 2 mounting holes; 4 leads



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UNIT	A	b	c	D	D1	e	E	E1	F	Н	H1	L	р	Q	q	U1	$U_2$	W1	W <sub>2</sub>
mm	4.72	4.93	0.15	20.02	19.96	7.00	9.50	9.53	1.14	19.94	12.98	5.33	3.38	1.70	27.94	34.16	9.91	0.25	0.51
	3.43	4.67	0.08	19.61	19.66	7.90	9.30	9.25	0.89	18.92	12.73	4.32	3.12	1.45	27.94	33.91	9.65	0.20 0	0.51
inches	0.186	0.194	0.006	0.788	0.786	0.311	0.374	0.375	0.045	0.785	0.511	0.210	0.133	0.067	1.100	1.345	0.390	0.01	0.02
menes	0.135	0.184	0.003	0.772	0.774	0.311	0.366	0.364	0.035	0.745	0.501	0.170	0.123	0.057	1.100	1.335	0.380	0.01	0.02

OUTLINE		REFERENCE		EUROPEAN	ISSUE DATE
VERSION	IEC	JEDEC	JEITA	PROJECTION	
PKG-B4E					03/12/2013

## **MK1160VP LDMOS TRANSISTOR**

### **Revision history**

#### Table 5. Document revision history

Date	Revision	Datasheet Status
2017/7/27	Rev 1.0	Preliminary Datasheet

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